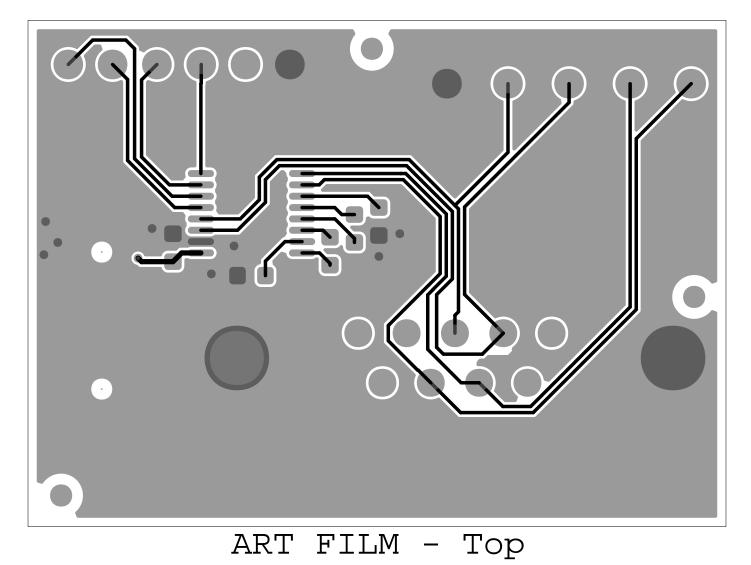
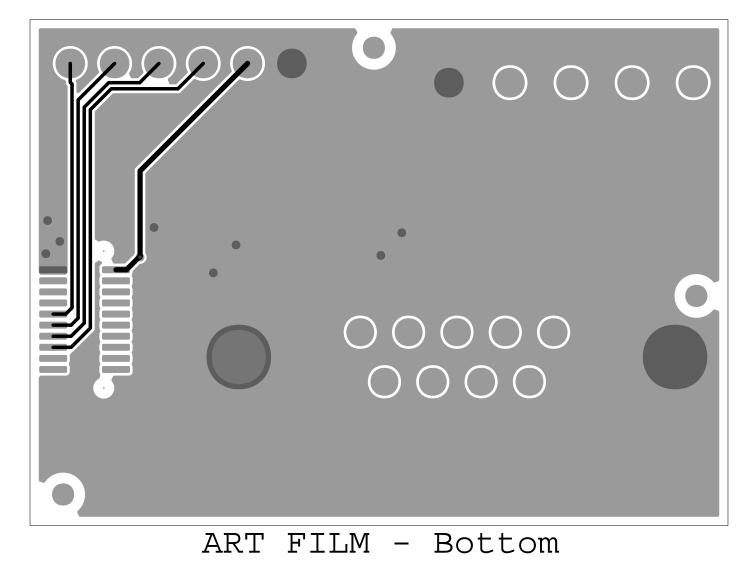
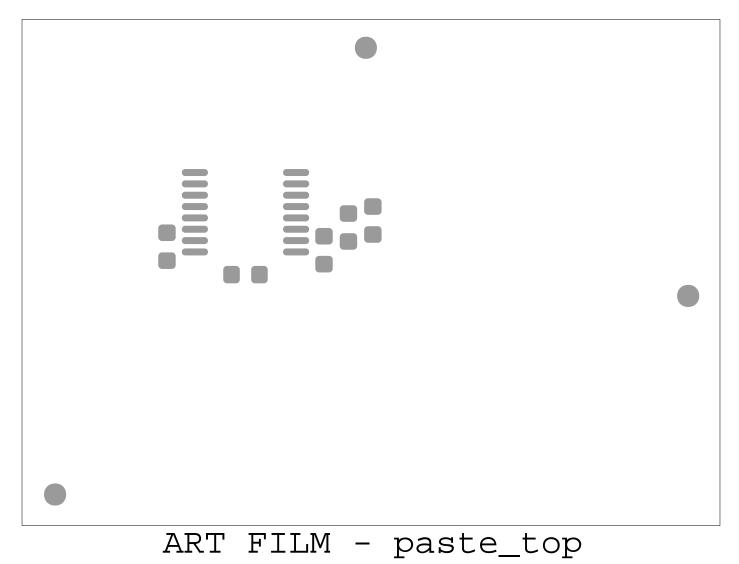
# ART FILM - Top



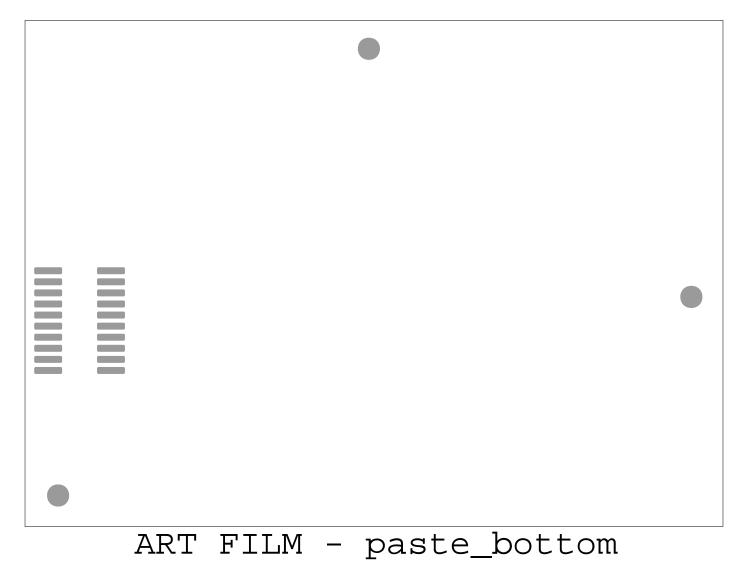
#### ART FILM - Bottom

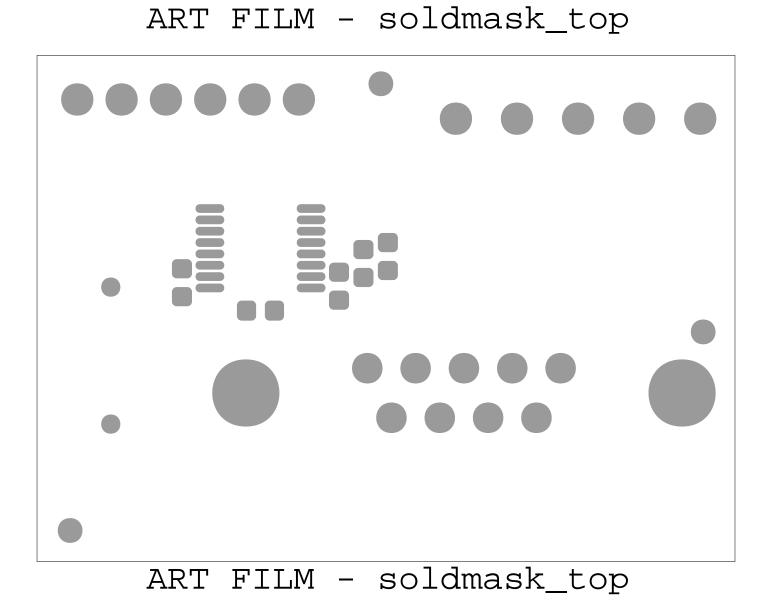


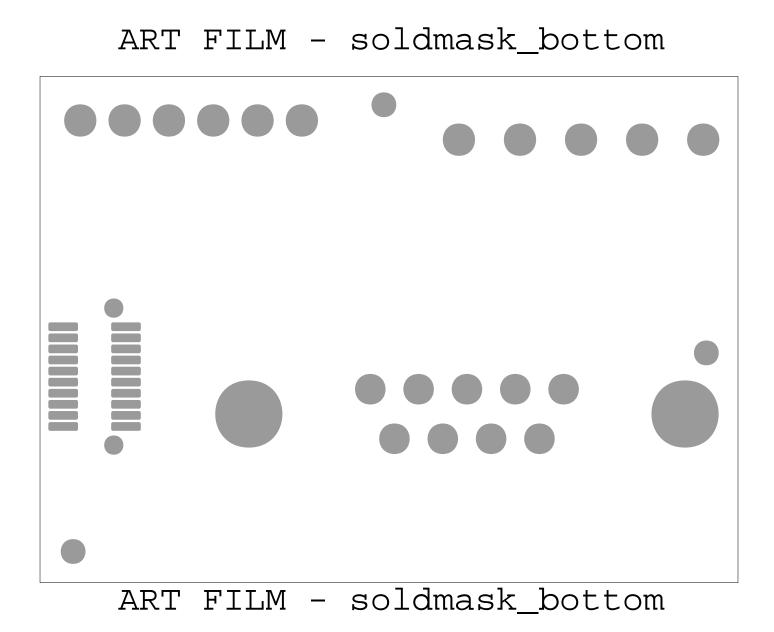
# ART FILM - paste\_top



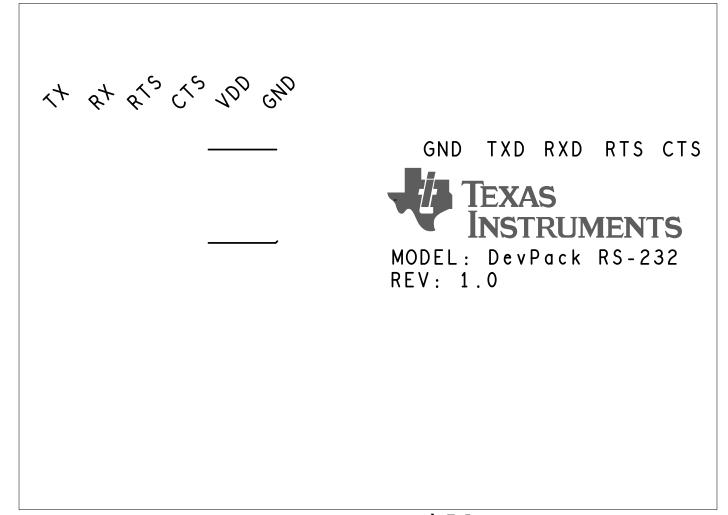
### ART FILM - paste\_bottom







#### ART FILM - silk\_top



## ART FILM - silk\_top

#### ART FILM - silk\_bottom



## ART FILM - silk\_bottom

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